

## Rogers Corporation Ultralam® 3850 Liquid Crystalline Polymer Circuit Material

Category : Polymer

### Material Notes:

ULTRALAM® 3850 laminate circuit materials utilize highly temperature resistant liquid crystalline polymer (LCP) as the dielectric film. Features & Benefits: Excellent high frequency properties, Stable electrical properties for tightly controlled impedance matching, Excellent thickness uniformity for maximum signal integrity, Allows use of thinner dielectric layer with minimal signal distortion, Good dimensional stability and low modulus, Bends easily for flex and conformal applications, Offers design flexibility and maximizes circuit density requirements, Extremely low moisture absorption, Reduced bake times, Maintains stable electrical, mechanical and dimensional properties in humid environments, Flame Resistant, Halogen free, meets WEEE. Typical Applications: High speed switches and routers, Chip packaging, MEM's, Military satellites and radar sensors, Hybrid substrates, Handheld and RF devices, Base station antennas. Information provided by Rogers Corporation.

Order this product through the following link:

[http://www.lookpolymers.com/polymer\\_Rogers-Corporation-Ultralam-3850-Liquid-Crystalline-Polymer-Circuit-Material.php](http://www.lookpolymers.com/polymer_Rogers-Corporation-Ultralam-3850-Liquid-Crystalline-Polymer-Circuit-Material.php)

Physical Properties	Metric	English	Comments
Density	1.40 g/cc	0.0506 lb/in <sup>3</sup>	
Water Absorption	0.040 % @Time 86400 sec	0.040 % @Time 24.0 hour	IPC 2.6.2
Thickness	25.4 - 102 microns	1.00 - 4.00 mil	Range of Standard Thicknesses

Mechanical Properties	Metric	English	Comments
Tensile Strength	200 MPa	29000 psi	IPC 2.4.16
Tensile Modulus	2.25 GPa	327 ksi	IPC 2.4.19
Tear Strength Test	>= 1.4	>= 1.4	kg; IPC 2.4.16
Peel Strength	1.49 kN/m	8.52 pli	1/2 oz. ED foil; IPC 2.4.8

Thermal Properties	Metric	English	Comments
CTE, linear	17.0 µm/m-°C @Temperature 30.0 - 150 °C	9.44 µin/in-°F @Temperature 86.0 - 302 °F	X-, Y-Direction; IPC 2.4.41.3
	150 µm/m-°C @Temperature 30.0 - 150 °C	83.3 µin/in-°F @Temperature 86.0 - 302 °F	Z-Direction; IPC 2.4.41.3
Thermal Conductivity	0.200 W/m-K	1.39 BTU-in/hr-ft <sup>2</sup> -°F	ASTM C518
Melting Point	315 °C	599 °F	DSC

Thermal Properties	Metric °C	English °F	Comments
UL RTI, Mechanical without Impact	190 °C	374 °F	
Flammability, UL94	V-0	V-0	

Electrical Properties	Metric	English	Comments
Volume Resistivity	1.00e+18 ohm-cm	1.00e+18 ohm-cm	IPC 2.5.17.1
Surface Resistance	1.00e+16 ohm	1.00e+16 ohm	IPC 2.5.17.1
Dielectric Constant	2.9 @Frequency 1.00e+10 Hz	2.9 @Frequency 1.00e+10 Hz	IPC-TM-650 2.5.5.5.1
Dielectric Strength	138 kV/mm	3500 kV/in	ASTM D149
Dissipation Factor	0.0025 @Frequency 1.00e+10 Hz	0.0025 @Frequency 1.00e+10 Hz	IPC-TM-650 2.5.5.5.1

Descriptive Properties	Value	Comments
Chemical Resistance	98.7 percent	IPC 2.3.4.2
Coefficient of Hygroscopic Expansion	4 ppm/%RH	60°C
Dimensional Stability	-0.03%	TD; IPC 2.2.4 method B
	-0.06 %	MD; IPC 2.2.4 method B
Solder Float	pass	IPC 2.4.13, Method B; 288°C
Thermal Coefficient of Dielectric Constant	24 ppm/°C	IPC 2.5.5.5; 8GHz; -50°C to 150°C

## Contact Songhan Plastic Technology Co.,Ltd.

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